

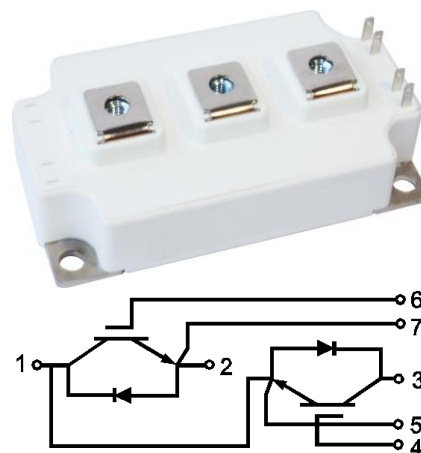


SYMT200HF120T2VH-M

IGBT Module

Features:

- Field Stop Trench Gate IGBT
- Short Circuit Rated $>10\mu\text{s}$
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested ($2 \times I_c$)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



Applications:

- Welding
- HEV Inverter
- Industrial Motor Drives
- UPS

Maximum Rated Values of IGBT($T_C=25^\circ\text{C}$ unless otherwise specified)

V_{CES}	Collector-Emitter Blocking Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	Continuous Collector Current	$T_C=100^\circ\text{C}$	200	A
		$T_C=25^\circ\text{C}$	400	A
I_{CM}	Repetitive Peak Collector Current	$T_J=175^\circ\text{C}$	400	A
t_{SC}	Short Circuit Withstand Time		>10	μs
P_D	Maximum Power Dissipation per IGBT	$T_C=25^\circ\text{C}$ $T_{Jmax}=175^\circ\text{C}$	1440	W

Electrical Characteristics of IGBT (T_C=25°C unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
V _{GE(th)}	Gate-Emitter Threshold Voltage	I _C =4mA, V _{CE} =V _{GE}	5.0	5.7	6.8	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 200A, V _{GE} = 15V	T _J =25°C	1.60		V
			T _J =125°C	1.80		V
			T _J =150°C	1.90		V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V, V _{CE} =V _{CES} , T _J =25°C			1	mA
I _{GES}	Gate-Emitter Leakage Current	V _{GE} = ±20V, V _{CE} = 0V, T _J =25°C			400	nA
C _{ies}	Input Capacitance	V _{CE} =25V, V _{GE} =0V, f=1MHz		16.6		nF
C _{res}	Reverse Transfer Capacitance			0.58		nF

Switching Characteristics

Switching Characteristics							
$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 600V, I_C = 200A,$ $R_{Gon} = 2\Omega, V_{GE} = \pm 15V,$ Inductive Load	$T_J = 25^{\circ}C$		0.31		μs
			$T_J = 125^{\circ}C$		0.31		
			$T_J = 150^{\circ}C$		0.31		
t_r	Rise Time		$T_J = 25^{\circ}C$		0.10		μs
			$T_J = 125^{\circ}C$		0.11		
			$T_J = 150^{\circ}C$		0.11		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^{\circ}C$		0.31		μs
			$T_J = 125^{\circ}C$		0.33		
			$T_J = 150^{\circ}C$		0.34		
t_f	Fall Time	$T_J = 25^{\circ}C$		0.18		μs	
		$T_J = 125^{\circ}C$		0.32			
		$T_J = 150^{\circ}C$		0.34			
E_{on}	Turn-on Switching Loss	$V_{CC} = 600V, I_C = 200A,$ $R_{Gon} = 2\Omega, V_{GE} = \pm 15V,$ $di/dt = 1620A/\mu s$ ($T_J = 150^{\circ}C$) Inductive Load	$T_J = 25^{\circ}C$		14.7		mJ
		$T_J = 125^{\circ}C$		18.9			
		$T_J = 150^{\circ}C$		20.2			

E _{off}	Turn-off Switching Loss	V _{CC} = 600V, I _C = 200A, R _{Goff} = 2Ω, V _{GE} = ±15V, du/dt=3765V/μs (T _J =150°C) Inductive Load	T _J =25°C		15.7		mJ
			T _J =125°C		22.7		
			T _J =150°C		24.7		
Q _g	Total Gate Charge	V _{GE} =+15V...-15V	T _J =25°C		1.07		μC
R _{g internal}	Internal Gate Resistance		T _J =25°C		3.75		Ω
RBSOA	I _C =400A, V _{CC} =1050V, V _p =1200V, R _{Goff} = 2Ω, V _{GE} =+15V to 0V, T _J =150°C			Trapezoid			
I _{sc}	SC Data	V _{CC} =600V, V _{GE} =±15V, R _{Gon} =4.7ohm, R _{Goff} =4.7ohm, tp=10us, T _J =150°C, Inductive Load			994		A
R _{θJC}	IGBT Thermal Resistance: Junction-To-Case(per leg)				0.104		°C/W

Maximum Rated Values of Diode (T_C=25°C unless otherwise specified)

V _{RRM}	Repetitive Peak Reverse Voltage	1200	V
I _F	Diode Continuous Forward Current	200	A
I _{FM}	Diode Maximum Forward Current	400	A

Electrical Characteristics of Diode (T_C=25°C unless otherwise specified)

Symbol	Description	Conditions		Min	Typ	Max	Unit
V _{FM}	Forward Voltage	I _F =200A	T _J =25℃		1.60		V
			T _J =125℃		1.70		
			T _J =150℃		1.70		
t _{rr}	Reverse Recovery Time	I _F = 200A, -di _F /dt =1855A/μs(T _J =150℃), V _R = 600V, V _{GE} = -15V	T _J =25℃		0.32		μs
			T _J =125℃		0.53		
			T _J =150℃		0.56		
I _{rr}	Peak Reverse Recovery Current		T _J =25℃		128		A
			T _J =125℃		144		
			T _J =150℃		150		
Q _{rr}	Reverse Recovery Charge		T _J =25℃		20.7		μC
			T _J =125℃		34.5		
			T _J =150℃		38.8		

E _{rec}	Reverse Recovery Energy	I _F = 200A, -diF/dt =1855A/μs(T _J =150 °C), V _R = 600V, V _{GE} = -15V	T _J =25 °C		8.5		mJ
			T _J =125 °C		14.1		
			T _J =150 °C		16.5		
R _{θJC}	Diode Thermal Resistance: Junction-To-Case (per leg)				0.166		°C/W

Module

Symbol	Description		Min	Typ	Max	Unit
V _{iso}	Isolation Voltage (All Terminals Shorted)	f = 50Hz, 1minute	2500			V
T _J	Maximum Junction Temperature				175	°C
T _{JOP}	Maximum Operating Junction Temperature Range		-40		+150	°C
T _{stg}	Storage Temperature		-40		+125	°C
CTI	Comparative Tracking Index		200			V
R _{θCS}	Case-To-Sink Thermally (Conductive Grease Applied)			0.03		°C/W
T	Power Terminals Screw:M6		3.0		5.0	N·m
T	Mounting Screw:M6		4.0		6.0	N·m
G	Weight			300		g

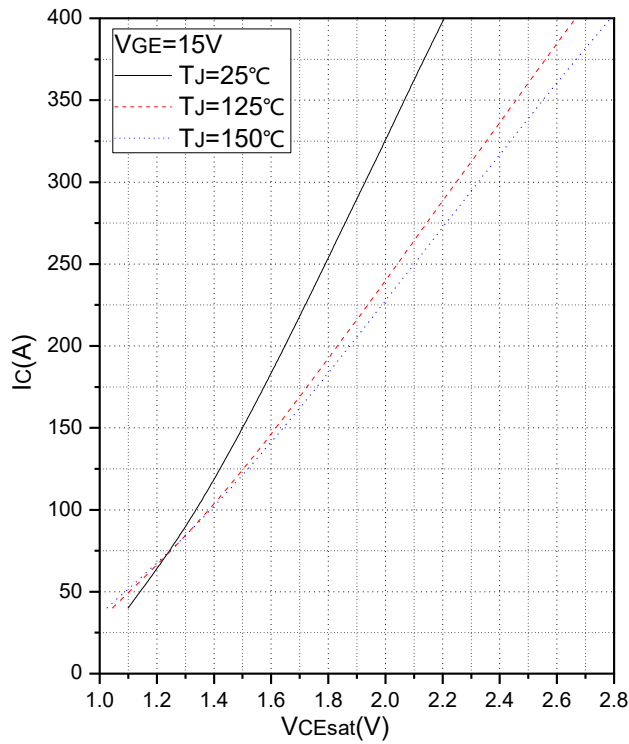


Fig.1 Typical Saturation Voltage Characteristics

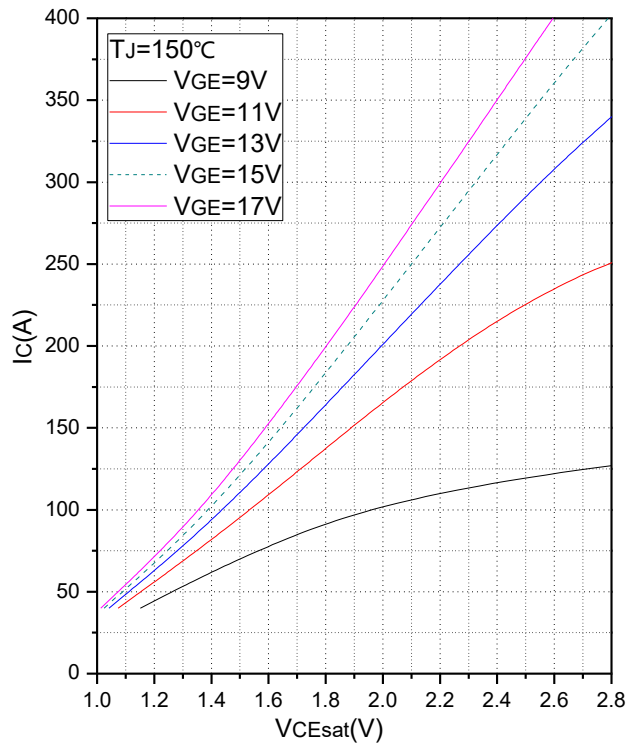


Fig.2 Typical Output Characteristics

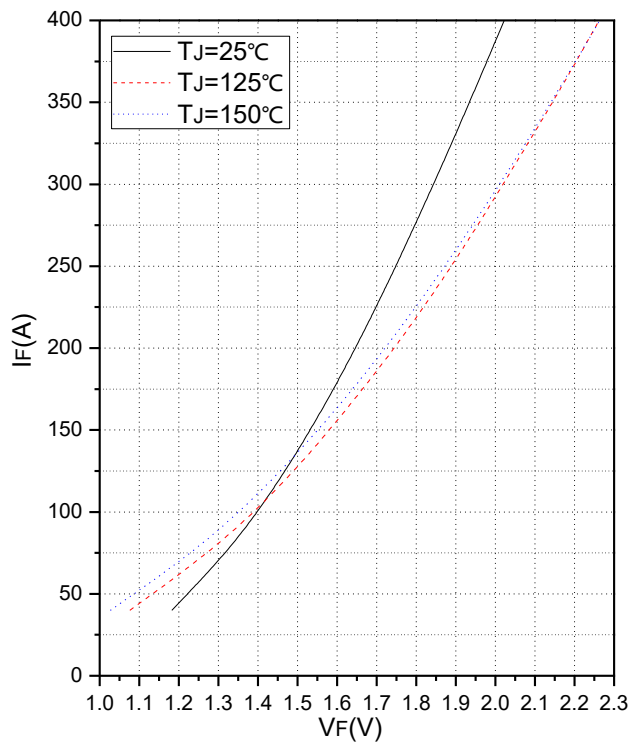


Fig.3 Forward Characteristics of Diode

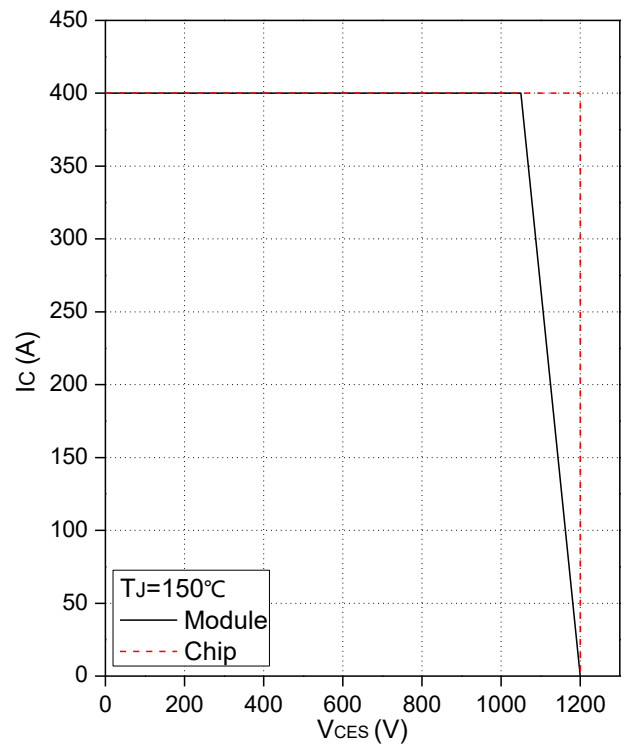
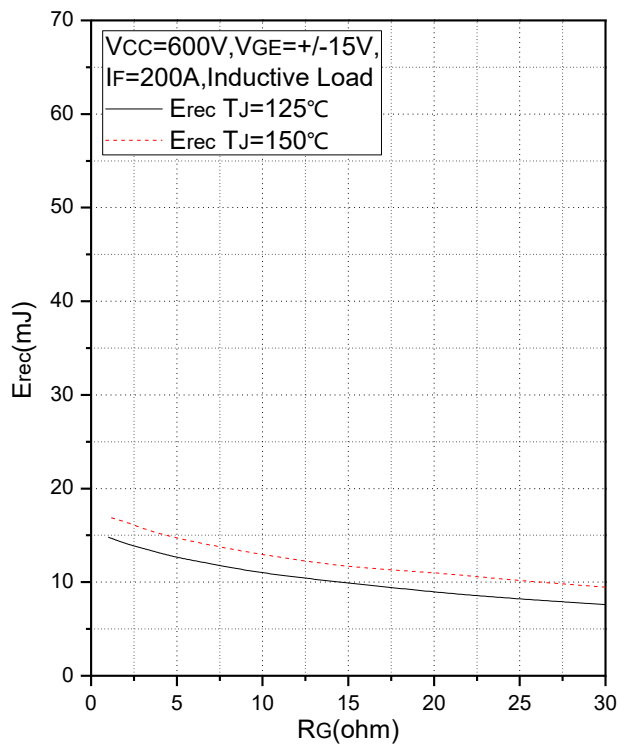
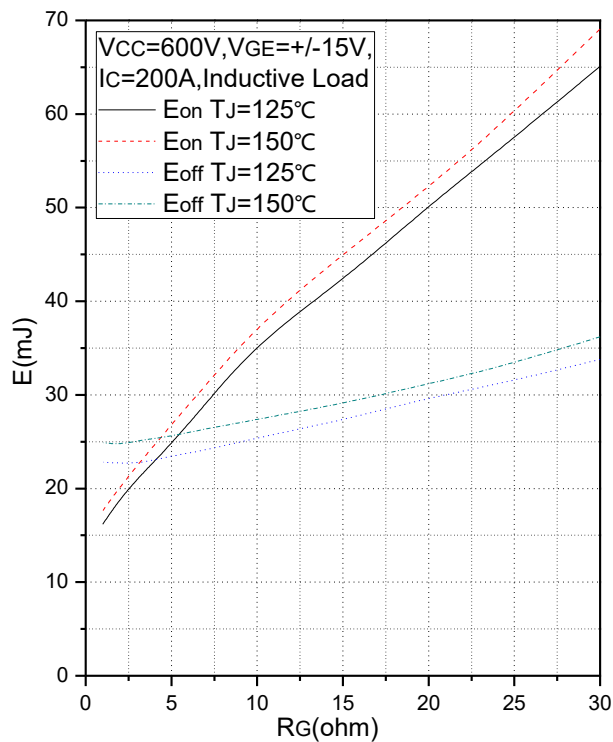
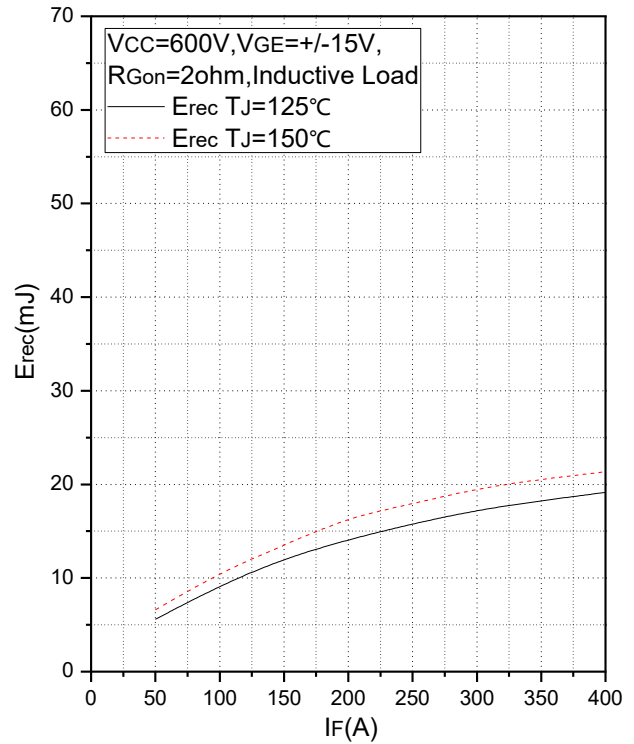
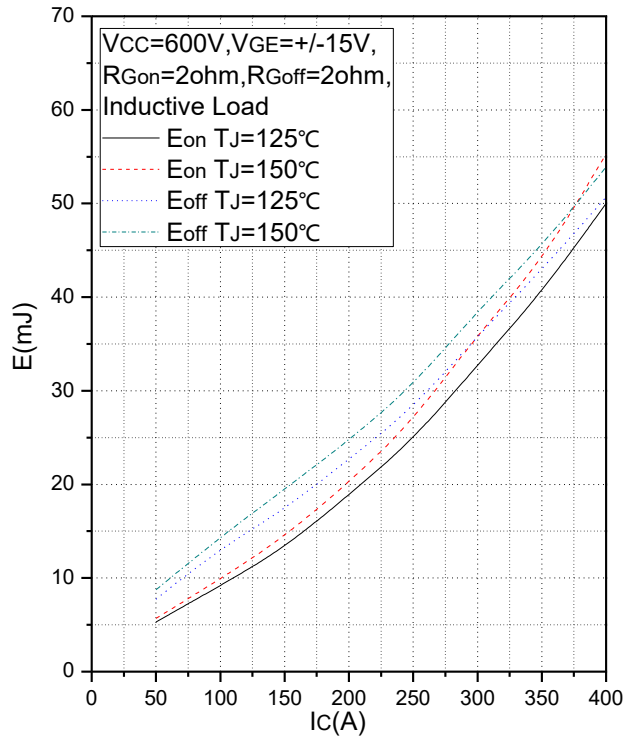


Fig.4 Reverse Bias Safe Operation Area (RBSOA)



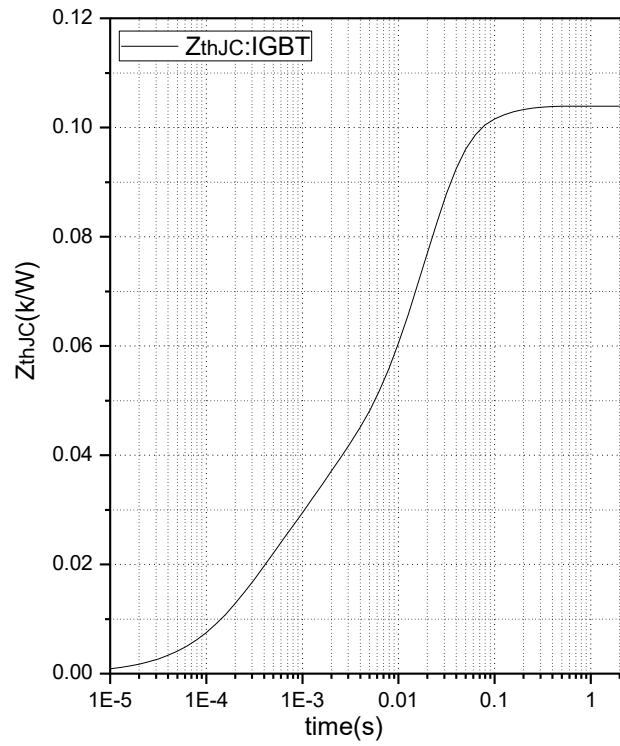


Fig.9 Transient Thermal Impedance (IGBT)

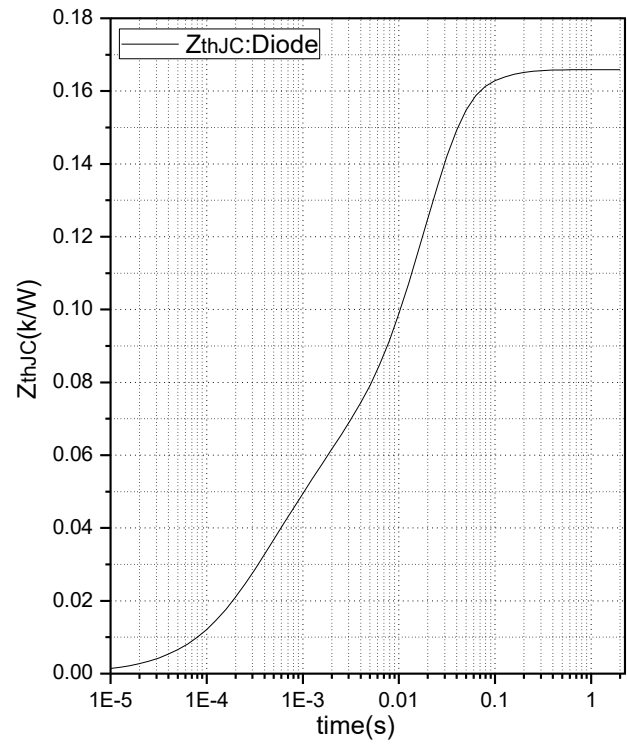
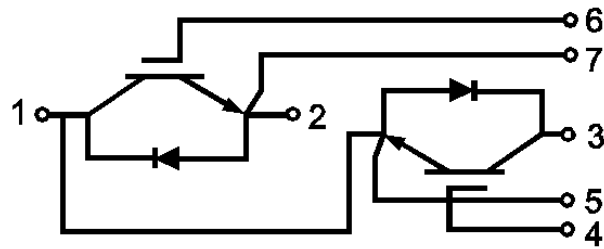


Fig.10 Transient Thermal Impedance (Diode)

Internal Circuit



Package Outline (Unit: mm):

